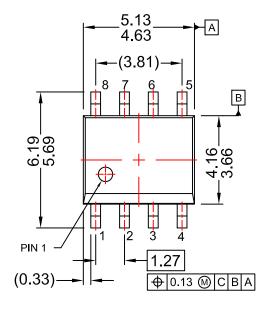
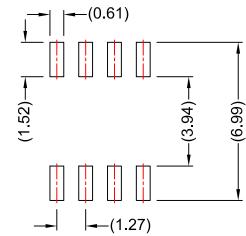
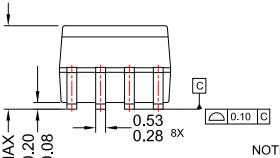
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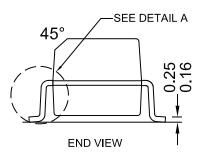
**DATE 30 SEP 2016** 



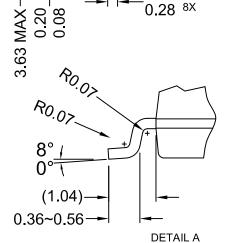


LAND PATTERN RECOMMENDATION





NOTES:



SCALE: 2:1

- A) NO STANDARD APPLIES TO THIS PACKAGE
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
- D) LANDPATTERN STANDARD: SOIC127P600X175-8M.

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DESCRIPTION:	SOIC8		PAGE 1 OF 1

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